

High Power Type

Ultra Miniature Style [MMP Series]



INTRODUCTION

The MMP Series Melf Metal Film High Power Resistors are manufactured using a vacuum sputtering system to deposit multiple layers of mixed metal alloys and passivative materials onto a carefully treated high grade ceramic substrate. SMD enabled structure and high power in small packages. The resistors are coated with layers of lacquer:

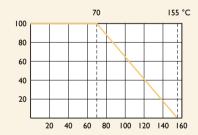
FEATURES

Power Rating	IW, 2W
Resistance Tolerance	±1%, ±2%, ±5%
T.C.R.	±50ppm/°C, ±100ppm/°C

DERATING CURVE

For resistors operated in ambient temperatures above 70°C, power rating must be derated in accordance with the curve below.

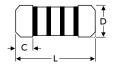
Rated Load (%)



Ambient Temperature (°C)

DIMENSIONS

Unit: mm



STYLE	DIMENSION			
Ultra Miniature	L	D	C Min.	
MMP100	5.9±0.2	2.2±0.1	0.5	
MMP200	8.5±0.2	3.2±0.2	0.5	

Note:			

ELECTRICAL CHARACTERISTICS

STYLE	MMP100	MMP200	
Power Rating at 70°C	IW	2W	
Maximum Working Voltage	350V		
Maximum Overload Voltage	700V		
Voltage Proof on Insulation	500V		
Resistance Range	I Ω - I Μ Ω & 0 Ω for E24 & E96 series value		
Operating Temp. Range	-55°C to +155°C		
Temperature Coefficient	±50ppm/°C, ±100ppm/°C		

Note: Special value is available on request

ENVIRONMENTAL CHARACTERISTICS

PERFORMANCE TEST	TEST METHOD	APPRAISE	
Short Time Overload	IEC 60115-1 4.13	2.5 times RCWV for 5 Sec.	±0.5%+0.05Ω
Voltage Proof on Insulation	IEC 60115-1 4.7	in V-block for 60 Sec., test voltage by type	By type
Temperature Coefficient	IEC 60115-1 4.8	-55°C to +155°C	By type
Insulation Resistance	IEC 60115-1 4.6	in V-block for 60 Sec.	>10,000ΜΩ
Solderability	IEC 60115-1 4.17	235±5°C for 3±0.5 Sec.	95% Min. coverage
Solvent Resistance of Marking	IEC 60115-1 4.30	IPA for 5±0.5 Min, with ultrasonic	No deterioration of coatings and markings
Periodic-pulse Overload	IEC 60115-1 4.39	4 times RCWV 10,000 cycles (1 Sec. on, 25 Sec. off)	±1.0%+0.05Ω
Damp Heat Steady State	IEC 60115-1 4.24	40±2°C, 90-95% RH for 56 days, loaded with 0.1 times RCWV	±2.0%+0.1Ω
Endurance at 70°C	IEC 60115-1 4.25	70±2°C at RCWV for 1,000 Hr. (1.5 Hr. on, 0.5 Hr. off)	±2.0%+0.1Ω
Temperature Cycling	IEC 60115-1 4.19	-55°C ⇒ Room Temp. ⇒ +155°C ⇒ Room Temp. (5 cycles)	±0.75%+0.05Ω
Resistance to Soldering Heat	IEC 60115-1 4.18	260±3°C for 10±1 Sec., immersed to a point 3±0.5mm from the body	±0.5%+0.05Ω